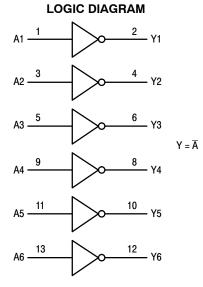
MC74HC05A

Hex Inverter with Open Drain Outputs

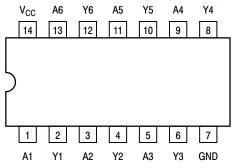
The MC74HC05A contains six inverters with open drain outputs. The MC74HC05A is identical to the MC74HC04A, except for the open drain outputs. The outputs can be connected to other open drain outputs to implement active LOW wired–OR or active High wired–AND logic functions. The open drain outputs require pull–up resistors to perform correctly.

Features

- Output Drive Capability: 10 LSTTL Loads with Suitable Pull-up Resistor
- Outputs Directly Interface to CMOS, NMOS and TTL
- High Noise Immunity Characteristic of CMOS Devices
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1 μA
- In Compliance With the JEDEC Standard No. 7A Requirements
- Chip Complexity: 36 FETs or 9 Equivalent Gates
- These are Pb-Free Devices



Pinout: 14-Lead Packages (Top View)

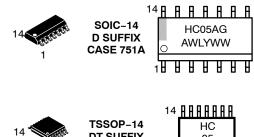


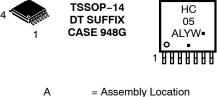


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MARKING DIAGRAMS





A = Assembly Location WL or L = Wafer Lot YY or Y = Year WW or W = Work Week G or • = Pb-Free Package

(Note: Microdot may be in either location)

FUNCTION TABLE

| Inputs | Outputs |
|--------|---------|
| А | Y |
| L | н |
| н | L |

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|--|-------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | - 0.5 to + 7.0 | V |
| V _{in} | DC Input Voltage (Referenced to GND) | -0.5 to V_CC + 0.5 | V |
| V _{out} | DC Output Voltage (Referenced to GND) | $-$ 0.5 to V_{CC} + 0.5 | V |
| l _{in} | DC Input Current, per Pin | ± 20 | mA |
| I _{out} | DC Output Current, per Pin | ± 25 | mA |
| I _{CC} | DC Supply Current, V _{CC} and GND Pins | ±50 | mA |
| PD | Power Dissipation in Still Air, SOIC Package† TSSOP Package† | 500 450 | mW |
| T _{stg} | Storage Temperature | – 65 to + 150 | °C |
| ΤL | Lead Temperature, 1 mm from Case for 10 Seconds SOIC or TSSOP Package | 260 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open. †Derating - SOIC Package: - 7 mV/°C from 65° to 125°C

TSSOP Package: - 6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | | Min | Max | Unit |
|------------------------------------|--|---|-----|-------------|--------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | | 2.0 | 6.0 | V | |
| V _{in} , V _{out} | DC Input Voltage, Output Voltage (Referenced to GND) | | | 0 | V _{CC} | V |
| T _A | Operating Temperature, All Package Types | | | - 55 | + 125 | °C |
| t _r , t _f | Input Rise and Fall Time (Figure 1) | V _{CC} = 2.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V | | 0 0 0 | 1000 500 400 | ns |

MC74HC05A

DC CHARACTERISTICS (Voltages Referenced to GND)

| | | | Vcc | Guaranteed Limit | | | |
|-----------------|---|---|-------------------|----------------------|----------------------|----------------------|------|
| Symbol | Parameter | Condition | v | –55 to 25°C | ≤ 85°C | ≤125°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage | $\begin{array}{l} V_{out} = 0.1V \text{ or } V_{CC} - 0.1V \\ \left I_{out} \right \leq 20 \mu A \end{array} \end{array}$ | 2.0 4.5 6.0 | 1.50 3.15 4.20 | 1.50 3.15 4.20 | 1.50 3.15 4.20 | V |
| VIL | Maximum Low-Level Input Voltage | $\begin{array}{l} V_{out} = 0.1V \text{ or } V_{CC} - 0.1V \\ \left I_{out} \right \leq 20 \mu A \end{array} \end{array} \label{eq:Vout}$ | 2.0 4.5 6.0 | 0.50 1.35 1.80 | 0.50 1.35 1.80 | 0.50 1.35 1.80 | V |
| V _{OL} | Maximum Low-Level Output Voltage | $\begin{split} V_{out} &= 0.1 V \text{ or } V_{CC} - 0.1 V \\ \left I_{out} \right &\leq 20 \mu A \end{split}$ | 2.0 4.5 6.0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | | 4.5 6.0 | 0.26 0.26 | 0.33 0.33 | 0.40 0.40 | |
| l _{in} | Maximum Input Leakage Current | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±1.0 | ±1.0 | μA |
| I _{CC} | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0\mu A$ | 6.0 | 1.0 | 10 | 40 | μA |
| I _{OZ} | Maximum Three-State Leakage Current | Output in High-Impedance State $V_{in} = V_{IL} \text{ or } V_{IH}$ $V_{out} = V_{CC} \text{ or } GND$ | 6.0 | ±0.5 | ±5.0 | ±10 | μA |

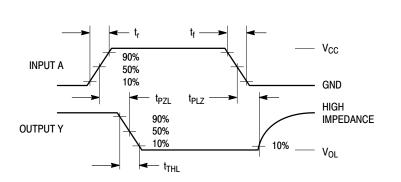
AC CHARACTERISTICS (C_L = 50pF, Input t_r = t_f = 6ns)

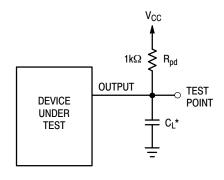
| | | v _{cc} | Guaranteed Limit | | | |
|--|--|-------------------|------------------|-----------------|-----------------|------|
| Symbol | Parameter | v | –55 to 25°C | ≤ 85°C | ≤125°C | Unit |
| t _{PLZ} , t _{PZL} | Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2) | 2.0 4.5 6.0 | 90 18 15 | 115 23 20 | 135 27 23 | ns |
| t _{THL} | Maximum Output Transition Time, Any Output (Figures 1 and 2) | 2.0 4.5 6.0 | 75 15 13 | 95 19 16 | 110 22 19 | ns |
| C _{in} | Maximum Input Capacitance | | 10 | 10 | 10 | pF |
| C _{out} | Maximum Three-State Output Capacitance (Output in High-Impedance State) | | 10 | 10 | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V, V _{EE} = 0 V | |
|-----------------|---|--|----|
| C _{PD} | Power Dissipation Capacitance (Per Buffer)* | 4.0 | pF |

*Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

MC74HC05A

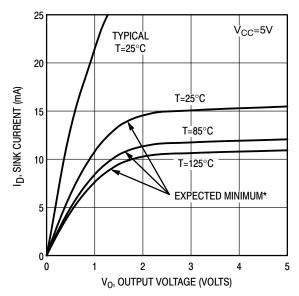




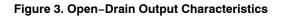
*Includes all probe and jig capacitance

Figure 1. Switching Waveforms





*The expected minimum curves are not guarantees, but are design aids.



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|------------------------|-----------------------|
| MC74HC05ADG | SOIC-14 (Pb-Free) | 55 / Rail |
| MC74HC05ADR2G | SOIC-14 (Pb-Free) | 2500 / Tape & Reel |
| MC74HC05ADTR2G | TSSOP-14* | |
| MC74HC05ADTG | TSSOP-14 (Pb-Free) | 96 / Tube |
| MC74HC05AFELG | SOEIAJ-14 (Pb-Free) | 2000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *This package is inherently Pb-Free.

DUSEU

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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DATE 03 FEB 2016

| STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE | STYLE 2: CANCELLED | STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE | STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE |
|---|---|---|---|
| STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE | STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE | STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE | STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE |

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